

MC100LVE222

Low Voltage 1:15 Differential $\div 1/\div 2$ ECL/PECL Clock Driver

The MC100LVE222 is a low skew 1:15 differential $\div 1/\div 2$ ECL fanout buffer designed with clock distribution in mind. The LVECL/LVPECL input signal pairs can be differential or used single-ended (with VBB output reference bypassed and connected to the unused input of a pair). Either of two fully differential clock inputs may be selected. Each of the four output banks of 2, 3, 4, and 6 differential pairs may be independently configured to fanout 1X or 1/2X of the input frequency. The LVE222 specifically guarantees low output to output skew. Optimal design, layout, and processing minimize skew within a device and from lot to lot.

The fsel pins and CLK_Sel pin are asynchronous control inputs. Any changes may cause indeterminate output states requiring a MR pulse to resynchronize any 1/2X outputs.

To ensure that the tight skew specification is realized, both sides of any differential output pair need to be terminated identically even if only one side is being used. When fewer than all fifteen pairs are used, identically terminate all the output pairs on the same package side whether used or unused. If no outputs on a side are used, then leave all these outputs open (unterminated). This will maintain minimum output skew. Failure to do this will result in a 10–20ps loss of skew margin (propagation delay) in the output(s) in use.

The MC100LVE222, as with most ECL devices, can be operated from a positive V_{CC} supply in PECL mode. This allows the LVE222 to be used for high performance clock distribution in +3.3V systems. Designers can take advantage of the LVE222's performance to distribute low skew clocks across the backplane or the board. In a PECL environment series or Thevenin line, terminations are typically used as they require no additional power supplies. All power supply pins must be connected. For more information on using PECL, designers should refer to Application Note AN1406/D. For a SPICE model, see Application Note AN1560/D.

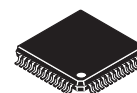
- 200ps Part-to-Part Skew
- 50ps Output-to-Output Skew
- Selectable 1x or 1/2x Frequency Outputs
- Extended Power Supply Range of $-3.0V$ to $-5.25V$ ($+3.0V$ to $+5.25V$)
- 52-Lead TQFP Packaging
- ESD > 2000V
- Moisture Sensitivity Level 2,
For Additional Information, See Application Note AND8003/D
- Flammability Rating: UL-94 code V-0 @ 1/8",
Oxygen Index 28 to 34
- Transistor Count = 684 devices



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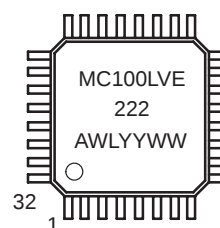
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TQFP
FA SUFFIX
CASE 848D

MARKING DIAGRAM*



A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

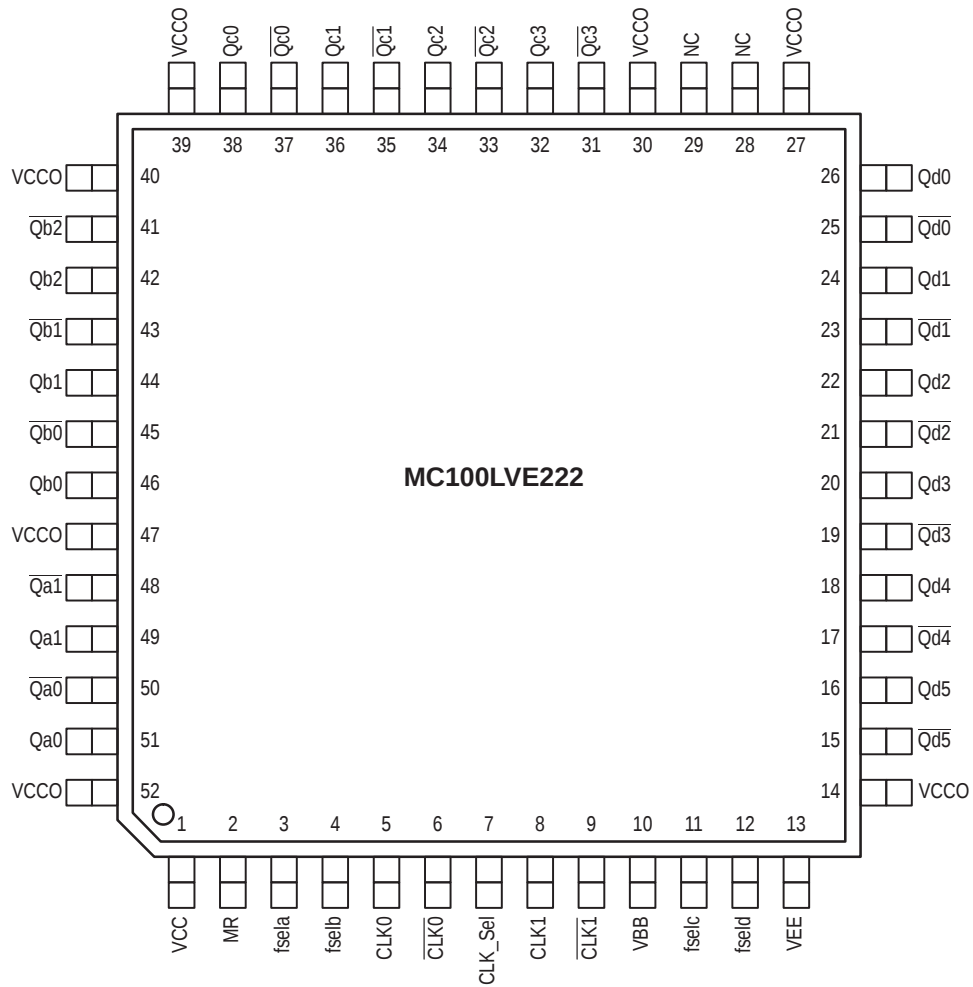
*For additional information, see Application Note AND8002/D

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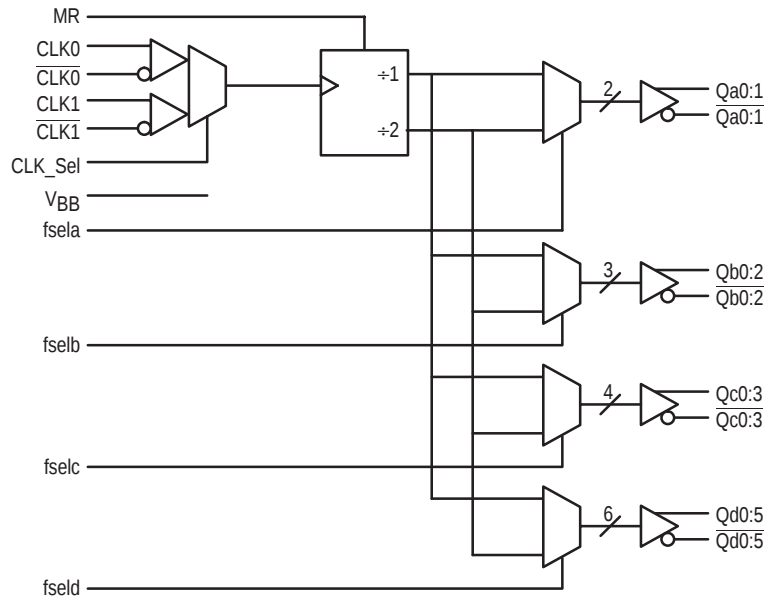
Device	Package	Shipping
MC100LVE222FA	TQFP	800 Units/Tray
MC100LVE222FAR2	TQFP	1500 Tape & Reel

MC100LVE222

Pinout: 52-Lead TQFP (Top View)



LOGIC SYMBOL



FUNCTION TABLE

Input	Function	
	0	1
MR	Active	Reset
CLK_Sel	CLK0	CLK1
fseln	+1	+2

MC100LVE222

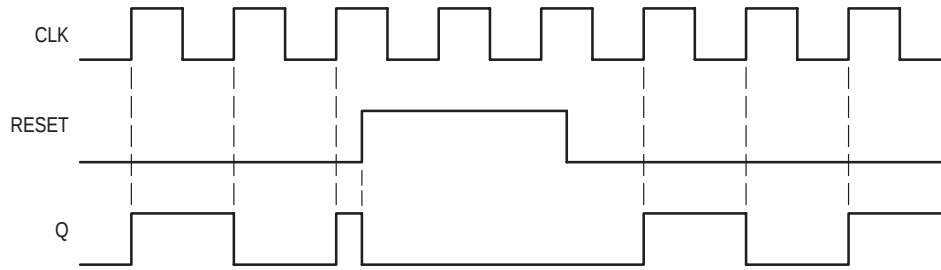


Figure 1. Timing Diagram

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V_{EE}	Power Supply ($V_{CC} = 0V$)	-8.0 to 0	VDC
V_I	Input Voltage ($V_{CC} = 0V$)	0 to -6.0	VDC
I_{out}	Output Current Continuous Surge	50 100	mA
T_A	Operating Temperature Range	-40 to +85	°C

* Maximum Ratings are those values beyond which damage to the device may occur.

ECL DC CHARACTERISTICS

Symbol	Characteristic	-40°C			0°C			25°C			70°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_{OH}	Output HIGH Voltage	-1.085	-1.005	-0.880	-1.025	-0.955	-0.880	-1.025	-0.955	-0.880	-1.025	-0.955	-0.880	V
V_{OL}	Output LOW Voltage	-1.830	-1.695	-1.555	-1.810	-1.705	-1.620	-1.810	-1.705	-1.620	-1.810	-1.705	-1.620	V
V_{IH}	Input HIGH Voltage	-1.165		-0.880	-1.165		-0.880	-1.165		-0.880	-1.165		-0.880	V
V_{IL}	Input LOW Voltage	-1.810		-1.475	-1.810		-1.475	-1.810		-1.475	-1.810		-1.475	V
V_{BB}	Output Reference Voltage	-1.38		-1.26	-1.38		-1.26	-1.38		-1.26	-1.38		-1.26	V
V_{EE}	Power Supply Voltage	-3.0		-5.25	-3.0		-5.25	-3.0		-5.25	-3.0		-5.25	V
I_{IH}	Input HIGH Current			150			150			150			150	μA
I_{IL}	Input $\overline{CLK0}$, $\overline{CLK1}$ LOW Current Others	-300 0.5			-300 0.5			-300 0.5			-300 0.5			μA
I_{EE}	Power Supply Current		122	136		122	136		122	136		125	139	mA

PECL DC CHARACTERISTICS

Symbol	Characteristic	-40°C			0°C			25°C			70°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_{OH}	Output HIGH Voltage ¹	2.215	2.295	2.420	2.275	2.345	2.420	2.275	2.345	2.420	2.275	2.345	2.420	V
V_{OL}	Output LOW Voltage ¹	1.470	1.605	1.745	1.490	1.595	1.680	1.490	1.595	1.680	1.490	1.595	1.680	V
V_{IH}	Input HIGH Voltage ¹	2.135		2.420	2.135		2.420	2.135		2.420	2.135		2.420	V
V_{IL}	Input LOW Voltage ¹	1.490		1.825	1.490		1.825	1.490		1.825	1.490		1.825	V
V_{BB}	Output Reference Voltage ¹	1.92		2.04	1.92		2.04	1.92		2.04	1.92		2.04	V
V_{CC}	Power Supply Voltage	3.0		5.25	3.0		5.25	3.0		5.25	3.0		5.25	V
I_{IH}	Input HIGH Current			150			150			150			150	μA
I_{IL}	Input $\overline{CLK0}$, $\overline{CLK1}$ LOW Current Others	-300 0.5			-300 0.5			-300 0.5			-300 0.5			μA
I_{EE}	Power Supply Current		122	136		122	136		122	136		125	139	mA

1. These values are for $V_{CC} = 3.3V$. Level Specifications will vary 1:1 with V_{CC} .

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ECL AC CHARACTERISTICS ($V_{EE} = V_{EE}(\min)$ to $V_{EE}(\max)$; $V_{CC} = V_{CCO} = GND$)

Symbol	Characteristic	-40°C			0°C			25°C			70°C			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
t_{PLH} t_{PHL}	Propagation Delay to Out-put IN (differential) IN (single-ended) MR	1040 990 1100	1140 1140 1250	1240 1290 1400	1060 1010 1130	1160 1160 1280	1260 1310 1430	1080 1030 1170	1180 1180 1320	1280 1330 1470	1120 1070 1220	1220 1370 1520	1320	ps	Note 1. Note 2.
t_{skew}	Within-Device Skew Part-to-Part Skew (Diff)			50 200			50 200			50 200			50 200	ps	Note 3.
V_{PP}	Minimum Input Swing	400			400			400			400			mV	Note 4.
V_{CMR}	Common Mode Range $V_{PP} < 500mV$	$V_{EE} + 1.3$		-0.4	$V_{EE} + 1.2$		-0.4	$V_{EE} + 1.2$		-0.4	$V_{EE} + 1.2$		-0.4	V	Note 5.
	$V_{PP} \geq 500mV$	$V_{EE} + 1.6$		-0.4	$V_{EE} + 1.5$		-0.4	$V_{EE} + 1.5$		-0.4	$V_{EE} + 1.5$		-0.4		
t_r/t_f	Output Rise/Fall Time	200		600	200		600	200		600	200		600	ps	20%–80%

1. The differential propagation delay is defined as the delay from the crossing points of the differential input signals to the crossing point of the differential output signals.
2. The single-ended propagation delay is defined as the delay from the 50% point of the input signal to the 50% point of the output signal.
3. The within-device skew is defined as the worst case difference between any two similar delay paths within a single device.
4. $V_{PP}(\min)$ is defined as the minimum input differential voltage which will cause no increase in the propagation delay. The $V_{PP}(\min)$ is AC limited for the LVE222. A differential input as low as 50 mV will still produce full ECL levels at the output.
5. V_{CMR} is defined as the range within which the V_{IH} level may vary, with the device still meeting the propagation delay specification. The V_{IL} level must be such that the peak to peak voltage is less than 1.0 V and greater than or equal to $V_{PP}(\min)$.

PECL AC CHARACTERISTICS ($V_{EE} = GND$; $V_{CC} = V_{CCO} = V_{CC}(\min)$ to $V_{CC}(\max)$)

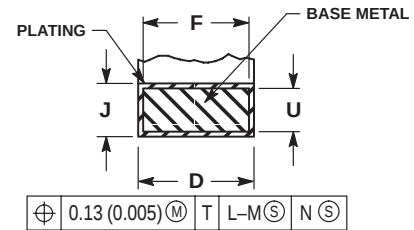
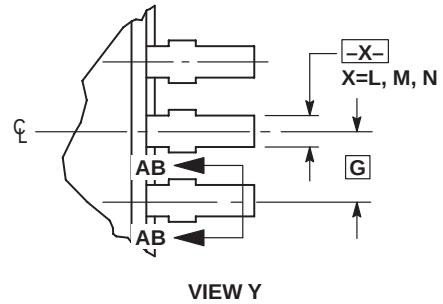
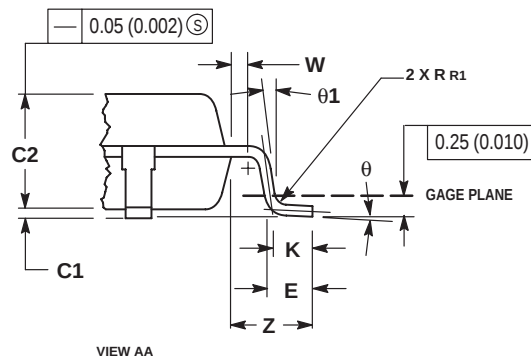
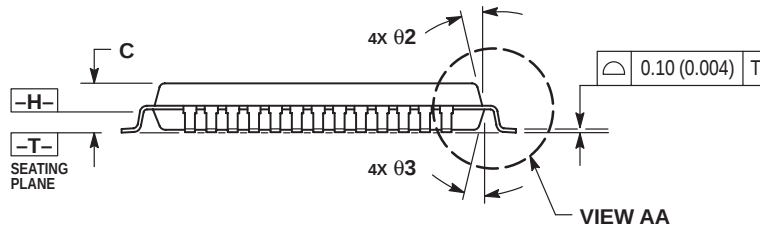
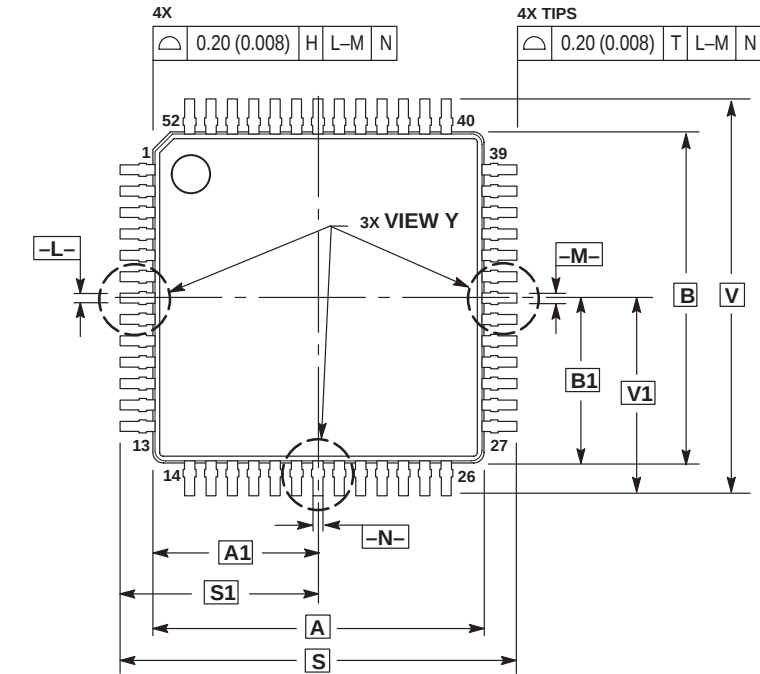
Symbol	Characteristic	-40°C			0°C			25°C			70°C			Unit	Condition
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
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t_{skew}	Within-Device Skew Part-to-Part Skew (Diff)			50 200			50 200			50 200			50 200	ps	Note 3.
V_{PP}	Minimum Input Swing	400			400			400			400			mV	Note 4.
V_{CMR}	Common Mode Range $V_{PP} < 500mV$	1.3		$V_{CC} - 0.4$	1.2		$V_{CC} - 0.4$	1.2		$V_{CC} - 0.4$	1.2		$V_{CC} - 0.4$	V	Note 5.
	$V_{PP} \geq 500mV$	1.6		$V_{CC} - 0.4$	1.5		$V_{CC} - 0.4$	1.5		$V_{CC} - 0.4$	1.5		$V_{CC} - 0.4$		
t_r/t_f	Output Rise/Fall Time	200		600	200		600	200		600	200		600	ps	20%–80%

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5. V_{CMR} is defined as the range within which the V_{IH} level may vary, with the device still meeting the propagation delay specification. The V_{IL} level must be such that the peak to peak voltage is less than 1.0 V and greater than or equal to $V_{PP}(\min)$.

MC100LVE222

PACKAGE DIMENSIONS

FA SUFFIX
TQFP PACKAGE
CASE 848D-03
ISSUE C



SECTION AB-AB
ROTATED 90° CLOCKWISE

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DATUM PLANE -H- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
4. DATUMS -L-, -M- AND -N- TO BE DETERMINED AT DATUM PLANE -H-.
5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -T-.
6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -H-.
7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.46 (0.018). MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD OR PROTRUSION 0.07 (0.003).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.00 BSC		0.394 BSC	
A1	5.00 BSC		0.197 BSC	
B	10.00 BSC		0.394 BSC	
B1	5.00 BSC		0.197 BSC	
C		1.70		0.067
C1	0.05	0.20	0.002	0.008
C2	1.30	1.50	0.051	0.059
D	0.20	0.40	0.008	0.016
E	0.45	0.75	0.018	0.030
F	0.22	0.35	0.009	0.014
G	0.65 BSC		0.026 BSC	
J	0.07	0.20	0.003	0.008
K	0.50 REF		0.020 REF	
R1	0.08	0.20	0.003	0.008
S	12.00 BSC		0.472 BSC	
S1	6.00 BSC		0.236 BSC	
U	0.09	0.16	0.004	0.006
V	12.00 BSC		0.472 BSC	
V1	6.00 BSC		0.236 BSC	
W	0.20 REF		0.008 REF	
Z	1.00 REF		0.039 REF	
θ	0°	7°	0°	7°
$\theta 1$	0°		0°	
$\theta 2$	12° REF		12° REF	
$\theta 3$	5°	13°	5°	13°

Notes

Notes

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